DUSEU

MOSFET – Dual P-Channel POWERTRENCH[®]

-20 V, -2.6 A, 142 $\mathbf{m}\Omega$

FDME1023PZT

Description

This device is designed specifically as a single package solution for the battery charges switch in cellular handset and other ultra-portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 1.6×1.6 Thin package offers exceptional thermal performance for it's physical size and is well suited to switching and linear mode applications.

Features

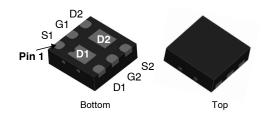
- Max $R_{DS(on)} = 142 \text{ m}\Omega$ at $V_{GS} = -4.5 \text{ V}$, $I_D = -2.3 \text{ A}$
- Max $R_{DS(on)} = 213 \text{ m}\Omega$ at $V_{GS} = -2.5 \text{ V}$, $I_D = -1.8 \text{ A}$
- Max $R_{DS(on)} = 331 \text{ m}\Omega$ at $V_{GS} = -1.8 \text{ V}$, $I_D = -1.5 \text{ A}$
- Max $R_{DS(on)} = 530 \text{ m}\Omega$ at $V_{GS} = -1.5 \text{ V}$, $I_D = -1.2 \text{ A}$
- Low Profile: 0.55 mm Maximum in the New Package MicroFET 1.6x1.6 Thin
- HBM ESD Protection Level > 1600 V (Note 3)
- NTATIVEFOR This Device is Pb–Free, Halide Free and RoHS Compliant
 Typical Applications
 Load Switch
 Battery Charging
 Battery Disconnect Switch

- Battery Disconnect Switch

ABSOLUTE MAXIMUM RATINGS (TA = 25°C unless otherwise noted)

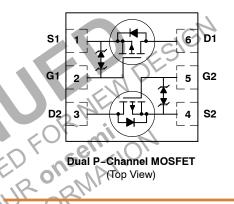
Symbol	Parameter	Value	Unit
V _{DS} 🗸	Drain to Source Voltage	-20	V
V _{GS}	Gate to Source Voltage	±8	V
Ι _D	Drain Current – Continuous (Note 1a) – Pulsed T _A = 25°C	-2.6 -6	A
P _D	$\begin{array}{l} \mbox{Power Dissipation for Single Operation} \\ - (\mbox{Note 1a}) & T_A = 25^\circ\mbox{C} \\ - (\mbox{Note 1b}) & T_A = 25^\circ\mbox{C} \end{array}$	1.4 0.6	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



UDFN6 1.6×1.6 0.5P (MicroFET[™] 1.6×1.6 Thin) CASE 517DW

ELECTRICAL CONNECTION



MARKING DIAGRAM



- = Assembly Plant Code &Z
- = 2-Digit Date Code (Year and Week) &2
- = 2-Digit Lot Run Code &K
- = Specific Device Code 2T

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

THERMAL CHARACTERISTICS

Q_{rr}

Reverse Recovery Charge

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Single Operation) (Note 1a)	90	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Single Operation) (Note 1b)	195	

ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Characteri	stics	•				
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = -250 μ A, V_{GS} = 0 V	-20	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25°C	-	-12	_	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -16 V, V_{GS} = 0 V	-	-	-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±10	μA
On Characteri	stics				10	7
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$	-0.4	-0.6	-1.0	V
$\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25°C	-	12	-	mV/°C
R _{DS(on)}	Drain to Source On Resistance	$V_{GS} = -4.5$ V, $I_D = -2.3$ A	' Hr	95	142	mΩ
		$V_{GS} = -2.5 \text{ V}, I_D = -1.8 \text{ A}$	105	120	213	
		$V_{GS} = -1.8$ V, $I_D = -1.5$ A	-0-	150	331	
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -1.2 \text{ A}$	A_{π}	190	530	mΩ
		$V_{GS} = -4.5 \text{ V, } I_D = -2.3 \text{ A},$ $T_J = 125^{\circ}\text{C}$	214	128	190	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = -4.5 \text{ V}, \text{ I}_{D} = -2.3 \text{ A}$	-	7	-	S
Dynamic Char	racteristics	A OF				
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$, f =1 MHz	-	305	405	pF
C _{oss}	Output Capacitance	J'NE	-	55	75	pF
C _{rss}	Reverse Transfer Capacitance		-	50	75	pF
Switching Cha	aracteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A},$	-	4.7	10	ns
t _r	Rise Time	$V_{GS} = -4.5 \text{ V}, \overline{\text{R}}_{\text{GEN}} = 6 \Omega$	-	4.8	10	ns
t _{d(off)}	Turn-Off Delay Time		-	33	53	ns
ťŕ	Fall Time		-	16	29	ns
Qg	Total Gate Charge	$V_{DD} = -10 \text{ V}, I_D = -2.3 \text{ A},$	-	5.5	7.7	nC
Q _{gs}	Gate to Source Gate Charge	$V_{GS} = -4.5 \text{ V}$	-	0.6	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	-	1.4	-	nC
Drain-Source	Diode Characteristics	•	-			
V_{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = -0.9 A (Note 2)	-	-0.8	-1.2	V
t _{rr}	Reverse Recovery Time	I _F = -2.3 A, di/dt = 100 A/μs		16	29	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

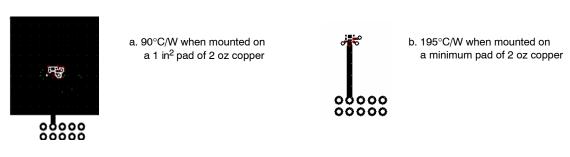
10

4.4

nC

NOTES:

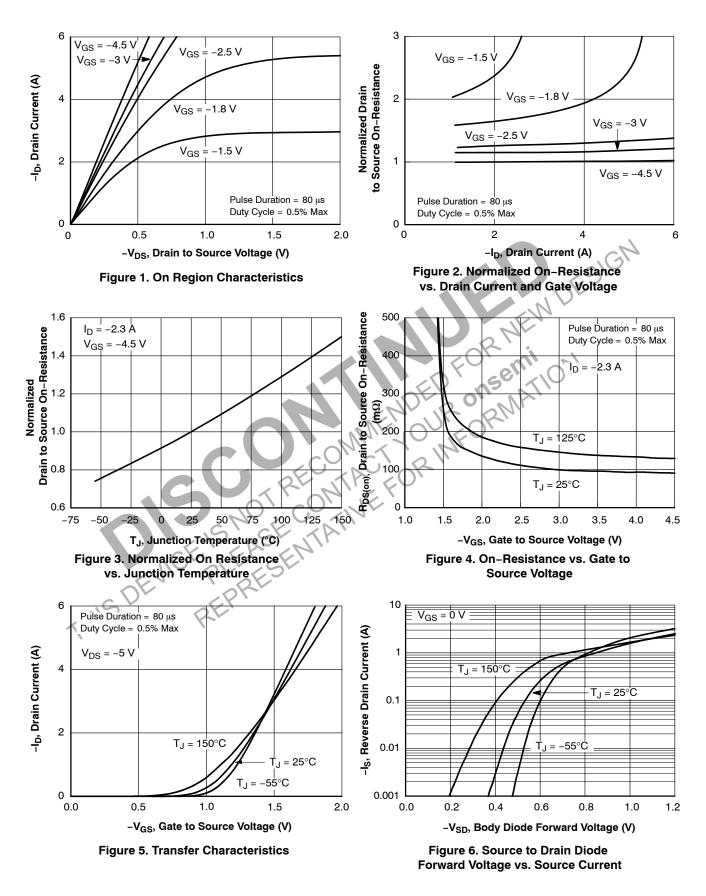
1. R_{0,JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.



- 2. Pulse Test : Pulse Width < 300 µs, Duty Cycle < 2.0%
- 3. The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)



TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

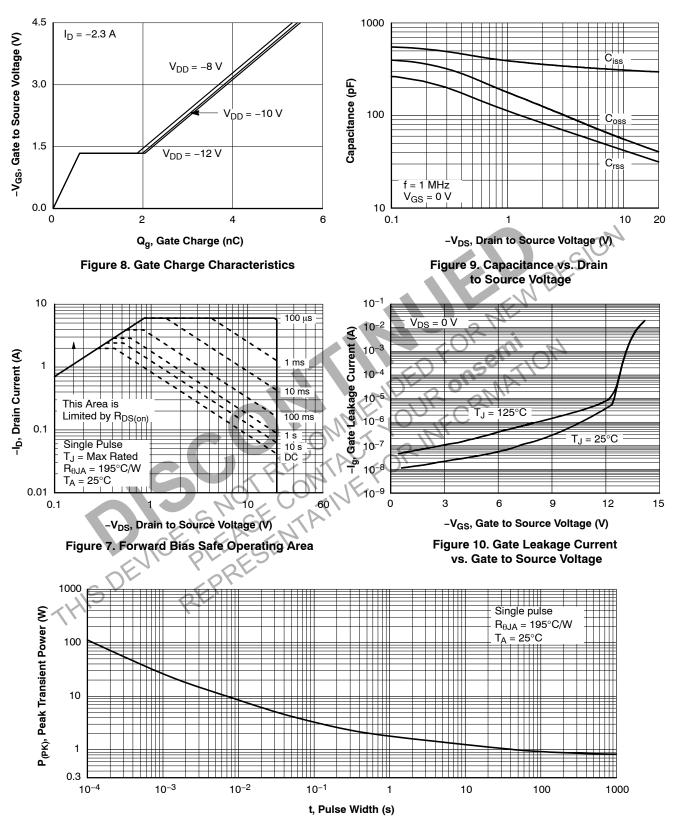


Figure 11. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (T, = 25°C unless otherwise noted) (continued)

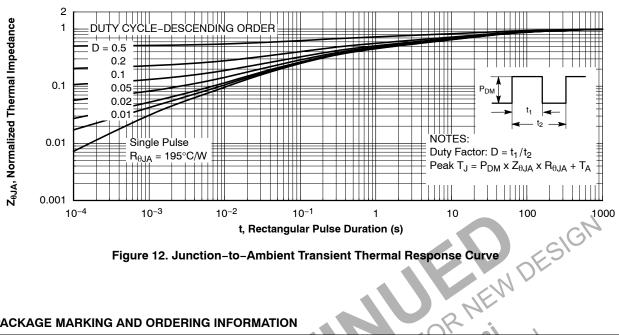


Figure 12. Junction-to-Ambient Transient Thermal Response Curve

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package Type	Reel Size	Tape Width	Shipping [†]
FDME1023PZT	2T	UDFN6 1.6×1.6 0.5P (MicroFET 1.6×1.6 Thin) (Pb-Free/Halide Free)	DETRO	8 mm	5000 / Tape & Reel
+For information on Specifications Broc	hure, <u>BRD8011/D</u> .	tions, including part orientation and the second se	nd tape sizes, pla	ease refer to our Ta	ape and Reel Packaging

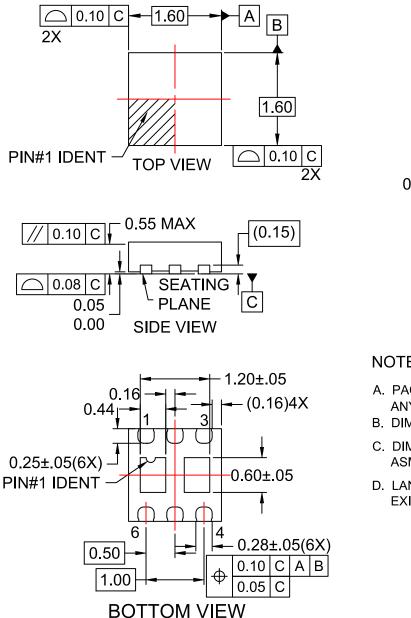
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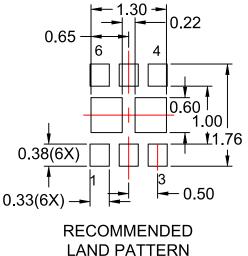
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UDFN6 1.6x1.6, 0.5P CASE 517DW ISSUE O

DATE 31 OCT 2016





NOTES:

- A. PACKAGE DOES NOT CONFORM TO ANY JEDEC STANDARD.
- **B. DIMENSIONS ARE IN MILLIMETERS.**
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

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